

IPI65R380C6-VB Datasheet

N-Channel 650V (D-S) Super Junction Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} at 25 °C (Ω)	$V_{GS} = 10 V$	0.330			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting

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- High-intensity discharge (HID)
- Fluorescent ballast lighting



TO-262

Top View

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	650	V	
Gate-Source Voltage			V _{GS}	± 30	1 V	
Continuous Drain Current (T. 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	1	13		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	V _{GS} at 10 V	T _C = 100 °C	I _D	8	А	
Pulsed Drain Current ^a			I _{DM}	39		
Linear Derating Factor				1.67	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	750	mJ	
Maximum Power Dissipation	PD	60	W			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C			
Drain-Source Voltage Slope T _J = 125 °C		-1) / /-14	50			
Reverse Diode dV/dt ^d			dV/dt	15	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				260	°C	

G

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD} = 100 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 30mH, $R_g = 25 \Omega$, $I_{AS} = 13A$.

c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

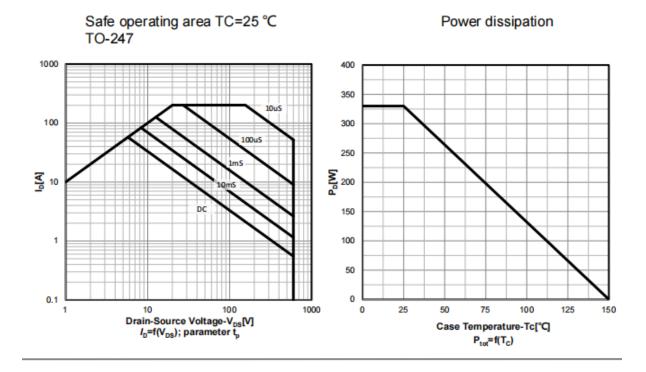


THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62 0 . 3 8				
Maximum Junction-to-Case (Drain)	R _{thJC}	-				°C/W		
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	••••••							
Drain-Source Breakdown Voltage	V _{DS}	VGS	= 0 V, I _D =	1 mA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$, I _D = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D =		2.5	-	4.5	V
	00(11)		$V_{GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	-	± 1	μA
			= 650V, V _G		-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}		-	V, TJ = 125 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		I _D =4.5A	-	0.330	-	Ω
Forward Transconductance	g fs	VDS	s = 30 V, I _D) = 4.5A	-	5.6	-	S
Dynamic								
Input Capacitance	C _{iss}		$\label{eq:VGS} \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 100 \ V, \end{array}$		-	2100	-	_
Output Capacitance	Coss				-	330	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-]	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	63	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{\rm DS} = 0$	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	213	-	
Total Gate Charge	Qg				-	38	-	1
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 20 A, V _{DS} = 520 V		-	39	-	nC
Gate-Drain Charge	Q _{gd}				-	47	-	1
Turn-On Delay Time	t _{d(on)}				-	18	25	
Rise Time	t _r	Vpp	V _{DD} = 520 V, I _D = 20A,		-	24	55	
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	80	-	- ns	
Fall Time	t _f			-	12	-		
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.8	-	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	13		
Pulsed Diode Forward Current	I _{SM}			-	-	39	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	-	1.5	V	
Reverse Recovery Time	t _{rr}	-	., _, _, _, , _, , , , , , , , , , , , ,		-	80	-	ns
Reverse Recovery Charge	Q _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 8 \text{ A}, \\ dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 400 \text{ V}$		-	5.8	-	μC	
Reverse Recovery Current	I _{RRM}			-	4 5	_	A	

Notes

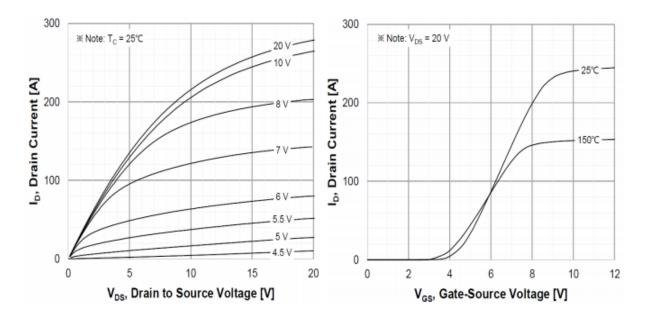
a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



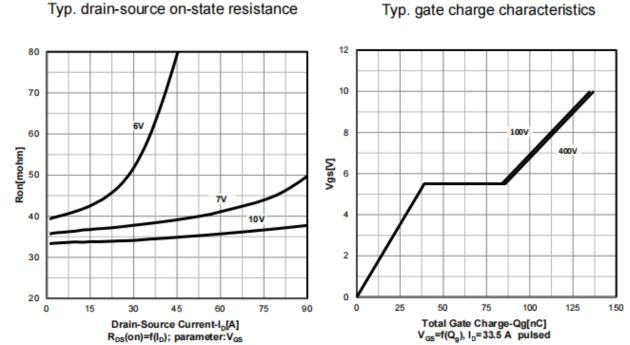


Typ. output characteristics T_i =25 $^{\circ}C$

Transfer characteristics



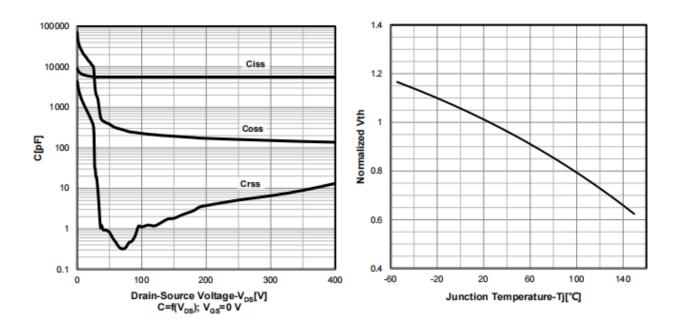




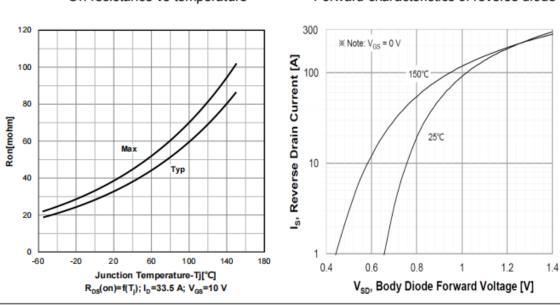
Typ. drain-source on-state resistance

Typ. capacitances

Normalized $V_{GS(th)}$ characteristics



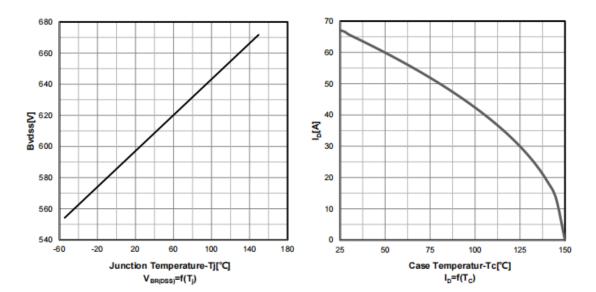




On-resistance vs temperature Forward characteristics of reverse diode

Drain-source breakdown voltage

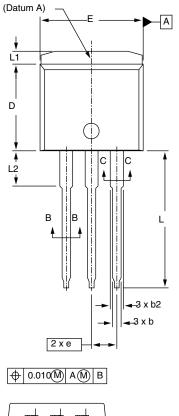
Drain current vs temperature

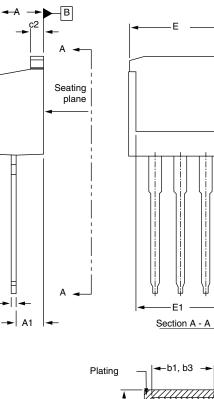


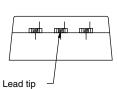


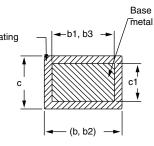
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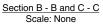
I²PAK (TO-262)











	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190
A1	2.03	3.02	0.080	0.119
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065

	MILLIM	ETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D	8.38	9.65	0.330	0.380
D1	6.86	-	0.270	-
E	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54 BSC		0.100 BSC	
L	13.46	14.10	0.530	0.555
L1	-	1.65	-	0.065
L2	3.56	3.71	0.140	0.146

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.

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С

3. Thermal pad contour optional within dimension E, L1, D1, and E1.4

. Dimension b1 and c1 apply to base metal only.



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